L Number	Hits	Search Text	DB	Time stamp
1	1	("5247423").PN.	USPAT	2002/07/25 19:30
2	4	"0555278"	JPO; DERWENT	2002/07/25 19:30
3	3	"555278"	JPO; DERWENT	2002/07/25 19:32
4	1	"5055278"	JPO; DERWENT	2002/07/25 19:32
5	2	"03211207"	JPO; DERWENT	2002/07/25 19:33
6	0	"055278"	JPO; DERWENT	2002/07/25 19:33
7	6557	tomonori	JPO; DERWENT	2002/07/25 19:33
8	2180	tomonori and device	JPO; DERWENT	2002/07/25 19:34
9	0	tomonori and (imprive adj handing)	JPO; DERWENT	2002/07/25 19:34
10	0	tomonori and (improve adj handing)	JPO; DERWENT	2002/07/25 19:34
11	1	tomonori and (improve adj handling)	JPO; DERWENT	2002/07/25 20:28
12	1	("5661086").PN.	USPAT	2002/07/25 21:49
13	32	5661086.URPN.	USPAT	2002/07/25 20:34
14	13099	(jig or (dicing adj sheet)) and frame	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 21:53
15	2548	((jig or (dicing adj sheet)) and frame) and lead	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 21:53
16	1048	(((jig or (dicing adj sheet)) and frame) and lead) and (chip or die)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 21:53
17	250	((((jig or (dicing adj sheet)) and frame) and lead) and (chip or die)) and polyimide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 21:55
18	176	(((((jig or (dicing adj sheet)) and frame) and lead) and (chip or die)) and polyimide) and (@ad<19990903)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 22:56
19	30	(polymide with substrate) and frame and (@ad<19990903)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 22:17
20	9	3774232.URPN.	USPAT	2002/07/25 22:13
21	11	257/$.ccls. and ((polyimide with substrate) and frame)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 22:16
22	460	257/$.ccls. and ((polyimide with substrate) and frame)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 22:16
23	330	(257/$.ccls. and ((polyimide with substrate) and frame)) and (@ad<19990903)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 22:17

24	291	((257/$.ccls. and ((polyimide with substrate) and frame)) and (@ad<19990903)) and (lead or leads or loc or luc)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 22:50
25	2	6111324.URPN.	USPAT	2002/07/25 22:27
26	11	5075760.URPN.	USPAT	2002/07/25 22:35
27	0	6177315.URPN.	USPAT	2002/07/25 22:45
28	5557	((tab or tape or poyimide) with (frame or substrate)) and ((frame or carrier) with (metal or rigid or reinforce or reinforcement))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 23:06
29	2027	(((tab or tape or poyimide) with (frame or substrate)) and ((frame or carrier) with (metal or rigid or reinforce or reinforcement))) and (lead or loc or luc)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 22:53
30	1708	((((tab or tape or poyimide) with (frame or substrate)) and ((frame or carrier) with (metal or rigid or reinforce or reinforcement))) and (lead or loc or luc)) and (@ad<19990903)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 22:58
31	413	(((((tab or tape or poyimide) with (frame or substrate)) and ((frame or carrier) with (metal or rigid or reinforce or reinforcement))) and (lead or loc or luc)) and (@ad<19990903)) and (slits or slit or slot)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 23:04
32	7	"L32" and polyimide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 23:05
33	7	"L32" and (polyimide or polymide)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 23:05
34	24	((poyimide or polymide) with (frame or substrate)) and ((frame or carrier) with (metal or rigid or reinforce or reinforcement))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/25 23:06